	PRODUCTS	TYPE			PAGE
	Silicon Monolithic integrated circu	integrated circuit BR9010/F/FV/RFV/RFVM-W		RFVM-W	1/20
♦STRUCTURE ♦PRODUCT ♦PART NUMBER ♦OUTLINE DIMENSIOI ♦BLOCK DIAGRAM ♦APPLICATION ♦FEATURES ♦FEATURES	Silicon Monolithic 64 x 16 bit Electric BR9010/F/F IS Fig1 (Plastic Mol Fig2 General Purpose •64words x 16 bit •Single power sup •Serial data I/O •Self-timed progra •Low supply curre Active Standby •Noise filter on tl •Write protection •Space Saving DI •High reliability Cl •100,000 erase/w •Provide 10 years •Easy connection •"FFFFh" stored	Integrated Circui cally Erasable Pro V/RFV/RFVI d) organization 1kbi ply amming cycle with nt (5V); 2mA (max (5V); 3uA (max))))))))))))))))))))))))))))))))))))	t ogrammable Ror M—W t serial EEPROI h auto-erase .) .) (CMOS INPL y is low 8/MSOP8pin P rance on shipped	n M JT) ackages	
	Parameter		Rating		Unit
Su	Supply Voltage Power dissipation		-0.3	~7.0	V
Pov			DIP8 SOP8 SSOPB8 MSOP8	800(※1) 450(※2) 300(※3) 310(※4)	mW
Stora	ge Temperature	Tstg	-65~125		°C
Opera	ing Temperature	Topr	-40~85		°C

Application example

Degradation is done at 8.0mW/°C for operation above Ta=25°C

Degradation is done at 4.5mW/°C for operation above Ta=25°C

Degradation is done at 3.0mW/°C for operation above Ta=25°C

Degradation is done at 3.1mW/°C for operation above Ta=25°C

Symbol

VCC

Vin

The application circuit is recommended for use. Make sure to confirm the adequacy of the characteristics. When using the circuit with changes to the external circuit constants, make sure to leave an adequate margin for external components including static and transitional characteristics as well as dispersion of the IC.

 $-0.3 \sim Vcc + 0.3$

Rating

2. 7~5. 5(WRITE)

2. 7~5. 5(READ)

0

~ VCC

V

Unit

v

Note that ROHM cannot provide adequate confirmation of patents.

♦ RECOMMENDED OPERATING CONDITION

Parameter

Supply Voltage

Input Voltage

Terminal Voltage

The product described in this specification is designed to be used with ordinary electronic equipment or devices (such as audio-visual equipment, office-automation equipment, communications devices, electrical appliances, and electronic toys).

Should you intend to use this product with equipment or devices which require an extremely high level of reliability and the malfunction of which would directly endanger human life (such as medical instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices), please be sure to consult with our sales representative in advance.

ROHM assumes no responsibility for use of any circuits described herein, conveys no license under any patent or other right, and makes no representations that the circuits are free from patent infringement.

	CHECK	APPROVAL	DATE :	' 02/03/14	SPECIFICATION No. :	TSZ02201-BR9010 /F/FV/RFV/RFVM-W-1-2
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PRODUCTS Silicon Monolithic integrated circuit TYPE BR9010/F/FV/RFV/RFVM-W PAGE 2/20

♦ ELECTRICAL CHARACTERISTICS

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Unless otherwise specified ($Ta = -40 \sim 85^{\circ}C$, VCC = 2. 7 ~ 5. 5V)

Devenueter	Sumbal		Limit		11	O Trita	Test
Parameter	Symbol	Min.	Тур.	Max.	Unit	Gondition	Circuit
Input Low Voltage 1	VIL1	_	_	0.3x VCC	v	DI Pin	
Input High Voltage 1	VIH1	0.7x VCC	_		v	DI Pin	
Input Low Voltage 2	VIL2	_		0.2x VCC	V	CS, SK, WC Pin	
Input High Voltage 2	VIH2	0.8x VCC	_	_	v	CS, SK, WC Pin	
Output Low Voltage	VOL	0		0.4	v	IOL=2.1mA	Fig.−4
Output High Voltage	∨он	VCC- 0.4		vcc	v	IOH=-0.4mA	Fig5
Input Leakage Current	ILI	-1	_	1	μA	VIN=0V~VCC	Fig6
Output Leakage Current	ILO	-1	_	1	μA	VOUT=0V~VCC,CS =VCC	Fig7
Occuration Comment	ICC1		_	2	mA	fSK=2MHz,tE/W=10ms (WRITE)	Fig8
	ICC2		_	1	mA	fSK=2MHz (READ)	Fig8
Standby Current	ISB			3	μA	CS,SK,DI,WC=VCC DO,R/B=OPEN	Fig9
Clock Frequency	fSK	-		2	MHz		

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Unless	otherwise	specified	(Ta = -	-40∼85℃、	VCC=2.	7~3. 3V)	
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Parameter	Symbol		Limit	Mary	Unit	Condition	Test
Input Low Voltage 1	VIL1		— -	0.3x	v	DI Pin	Gircuit
Input High Voltage 1	VIH1	0.7x VCC	_	-	v	DI Pin	
Input Low Voltage 2	VIL2	_	_	0.2x VCC	v	CS, SK, WC Pin	
Input High Voltage 2	VIH2	0.8x VCC	_	_	v	CS, SK, WC Pin	
Output Low Voltage	VOL	0	_	0.4	v	IOL=100uA	Fig4
Output High Voltage	∨он	VCC- 0.4	_	vcc	v	IOH=-100uA	Fig5
Input Leakage Current	ILI	-1	_	1	μΑ	VIN=0~VCC	Fig6
Output Leakage Current	ILO	-1	_	1	μA	VOUT=0~VCC,CS=VCC	Fig7
Operating Gurrent	ICC1	_		1.5	mA	fSK =2MHz,tE/W=10ms (WRITE)	Fig8
	ICC2	_	_	0.5	mA	fSK =2MHz (READ)	Fig8
Standby Current	ISB	_	_	2	μΑ	CS,SK,DI,WC=VCC DO,R/B=OPEN	Fig9
Clock Frequency	fSK	_	_	2	MHz		

OThis product is not designed for protection against radioactive rays.

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Terminal	IN/OUT	Function
VCC	_	Power Supply
GND	-	Ground (0V)
cs	INPUT	Chip Select Input
SK	INPUT	Serial Data Clock Input
DI	INPUT	Serial Data Input (Op code, address)
DO	OUTPUT	Serial Data Output
wc	INPUT	Write Control Input
R∕B	OUTPUT	READY/BUSY Status Output

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♦INSTRUCTION CODE

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Instruction	Start Bit	Op Code	Address	Data
READ	1010	1000	A0 A1 A2 A3 A4 A5 0 0	D0 D1 - D14 D15 (READ DATA)
WRITE	1010	0100	A0 A1 A2 A3 A4 A5 0 0	D0 D1 – D14 D15 (WRITE DATA)
Write Enable(WEN)	1010	0011	* * * * * * * *	
Write Disable(WDS)	1010	0000	* * * * * * * *	

Address and data must be transferred from LSB. "*" Means either VIH or VIL

\$SYNCHRONOUS DATA INPUT OUTPUT TIMING



Fig.-10 Synchronous data input output timing

OInput Data is clocked into the DI pin on the rising edge of the clock SK. OOutput data is clocked out on the falling edge of the SK clock. OThe WC pin does not have any affect on the READ, WEN and WDS operations. OBetween instructions, CS must be brought High for greater than the minimum of tCS. If CS is maintained Low, the next instruction isn't detected.



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AC OPERATION CHARACTERISTICS (Ta=-40~85°C, VCC=2. 7~5. 5V)

Parameter	Symbol	Min.	Тур.	Max.	Unit
Chip Select Setup Time	tCSS	100	_		ns
Chip Select Hold Time	tCSH	100	_	_	ns
Data In Setup Time	tDIS	100	_	_	ns
Data In Hold Time	tDIH	100	_	_	ns
Delay to Output High	tPD1	_	_	150	ns
Delay to Output Low	tPD0		-	150	ns
Self-Timed Program Cycle	tE/W	_	_	10	ms
Minimum Chip Select High Time	tCS	250		_	ns
Data Output Disable Time (From \overline{CS})	tOH	0	_	150	ns
Clock High Time	tWH	230	—		ns
Clock Low Time	tWL	230	_		ns
Write Control Setup Time	tWCS	0	_		ns
Write Control Hold Time	tWCH	0		- 	ns
Clock High to Output READY/BUSY Status	tSV	_	_	150	ns

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•The DO pin outputs the READY/BUSY status of the internal part, which shows whether the device is ready to receive the next instruction or not. (High or Low)

After the write instruction is completed, if \overline{CS} is brought from high to low while \overline{SK} is Low, the DO pin outputs the internal status.(The $\overline{R/B}$ pin may be no connection.)

When written to the memory cell, R/\overline{B} status is output after tSV spent from the rising edge of 32th clock on \overline{SK} .

 $R \swarrow B = Low$: under writing

After spending tE/W operating the internal timer, the device automatically finishes writing.

During tE/W, the memory array is accessed and any instruction is not received.

 $R \swarrow B = High$: ready

Auto programming has been completed. The device is ready to receive the next Instruction.



Fig.-14 READY/BUSY Status Output timing

 \diamond About the direct connection between the DI and DO pins

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The device can be used with the DI pin connected to the DO pin directly.

But when the READY/BUSY status is output, be careful about the bus conflict on the port of the controller.

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ROHM	PRODUCTS Silicon Monolithic integrated circuit	TYPE BR9010/F/FV/RFV/	′RFVM-W	PAGE 20/20
		1		
	ODE CANCEL			
	cuon		ſ	
<u>як</u> ———		32clocks		
DI	START BIT OPCODE ADDRI	ISS		
	4bit 4bit 8bit	16bit		
DO 😽	It is possible to	D0 DATA	D15	
WC Horl	-	be canceled for any liming.	•	
How to cancel :	CS is brought High.			
3-2. Write instruction	tion			
<u>як</u> ———		32clocks		
	4bit 4bit 8bit	16bit		
R/B			~~ t E/₩	
wc	a>₩<	b≫	(c)K -d-	*
	1	1	i	1
a : CS is brought Hig	h to cancel the instruction, and	WC may be either High or L	.ow.	
b : In case that WC is the da <u>ta o</u> f the sp	s brought High for a moment, or pecified address is not changed.	CS is brought High, the wri	te instruction is can	celed,
c : When WC is broug the instruction is	ght High, or the device is power canceled but the specified data	ed down (But the latter way is not guaranteed. Send the	is not recommende instruction again.	d),
d : When CS is broug	th High during R/B High, the de	vice is reset and ready to r	eceive a next instruc	stion.
NOTE : The doc	ument may be strategic techni	cal data subiect to COCO	V regulations.	
		-	_	
ROHM CO., LTD.	REV. : A	SPECIFICATION No. :	TSZ02201-BR /F/FV/RFV/RFV	9010 M-W-1-2

Notice

Precaution on using ROHM Products

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 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

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For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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